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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE REQUEST FOR FILING APPLICATION UNDER 37 C.F.R. 1.53(b) WITHOUT FILING FEE AND/OR WITHOUT EXECUTED INVENTOR'S DECLARATION

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Atty. Dkt. 330-275

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Ale Andria, VA 22313-1450

Sir:

Date: April 8, 2004

This is a request for filing a new PATENT APPLICATION under Rule 53(b) entitled: GLASS FOR WINDOW OF SEMICONDUCTOR PACKAGE, GLASS WINDOW FOR SEMICONDUCTOR PACKAGE. PROCESS FOR PRODUCTION OF GLASS WINDOW, AND SEMICONDUCTOR PACKAGE without a filing fee and/or without an executed inventor's oath/declaration. This application is made by the below identified inventor(s). Attached hereto are the following papers: Newly executed Declaration, Copy of Declaration from prior application, Abstract Please delete the following inventors in the continuation/division/continuation-in-part application: **Deleted** persons: pages of specification and claims (including 12 numbered claims), and 38 sheets of accompanying drawing/s for Figures Attached is a Power of Attorney. Priority is hereby claimed under 35 U.S.C. § 119 based on the following foreign applications: Day/Month/Year Filed **Application Number** Country 09 April 2003 2003-105037 JP , respectively, the entire content of which is hereby incorporated by reference in this application.. Certified copy(ies) of foreign application(s) is/are attached. Certified copy(ies) filed on in prior application no. This application claims the benefit of Provisional Application No. , the entire content of which is . filed hereby incorporated by reference in this application. This application is a \(\subseteq \text{continuation} / \subseteq \text{division} / \subseteq \text{continuation-in-part of Application No.} \) , filed , the entire content of which is hereby incorporated by reference in this application. Petition filed in prior application to extend its life to insure co-pendency. The prior application is assigned to It is hereby requested that the Examiner consider the art cited in the above parent application(s) by applicant and/or the Examiner for the reasons stated therein. A listing of that art is attached, but pursuant to Rule 98(d) copies are Applicant claims "small entity" status. ☐ "Small entity" statement attached. Please enter the attached preliminary amendment prior to calculation of filing fee: Also attached: Information Disclosure Statement; I Non-Publication Request; Nucleotide and/or Amino Acid Sequence Submission; Statement deleting Inventor(s) named in prior application; Other: Japanese Yoichi HACHITANI 1. Inventor: (citizenship) (last) (first) (state/country) Japan Residence: (city) c/o HOYA CORPORATION, 7-5, Naka-Ochiai 2-chome, Shinjuku-ku, Tokyo, Japan Mailing Address: (Zip Code) 161-0032 2. Inventor: (citizenship) MI (last) (first) Residence: (city) (state/country) Mailing Address: (Zip Code) ☐ See attached sheet(s) for additional inventor(s) information!! Address all future communications to NIXON & VANDERHYE P.C., 1100 North Glebe Road, 8th Floor, Arlington, VA 22201. **NIXON & VANDERHYE P.C.** Correspondence Address: By Atty: Arthur R. Crawford, Reg. No. 25,327 23117 **Customer Number:** Telephone: (703) 816-4000 Facsimile: (703) 816-4100 ARC:ecb Signature: